DIP Power Inductors

MBPL Series



PRODUCT IDENTIFICATION



SHAPE AND DIMENSIONS



Features

- Magnetic shielded construction for high density board assembly
- High performance execllent DC current characteristics
- Large energy storage capacity
- Up to 40 amps continuous
- Custom designs available

ELECTRICAL CHARACTERISTICS MBPL SERIES

PART NO.	INDUCTANCE at (µH)	TOLERANCE (±%)	TEST FREQUENCY (KHZ)	SER (KHZ) MIN.	DC RESISTANCE (mΩ)MAX	RATED CURRENT (A)MIN
MBPL1319B-R30M-S	0.30	20%	100		0.5	60
MBPL1319B-R60M-S	0.60	20%	100		1.0	60
MBPL1319B-R90M-S	0.90	20%	100		1.0	40
MBPL1319B-1R2M-S	1.20	20%	100		1.0	35
MBPL1220B-1R2M-S	1.20	20%	100		1.8	30
MBPL1220B-1R5M-S	1.50	20%	100		1.8	40
MBPL1217B-R30M-S	0.30	20%	100		0.7	45
MBPL1217B-R60M-S	0.60	20%	100		1.5	40
MBPL1217B-R90M-S	0.90	20%	100		1.5	30

Note: * at 25MHZ ** at 7.9MHZ

When ordering please specify tolerance and packaging code.

 Ex : PMC129- R60M-S
 Tolerance: M±20%, L±15%, K±10%
 Packaging: ClearTape and Reel (Standard)

 L Q :HP4287A
 SRF :HP8753D/E4991A
 RDC: Digital Multimeter SC-7401

Operating Temperature °C Range -40°C to +125°C

TAPE DIMENSIONS

Dimensions : mm

TAPE MATERIAL





REEL DIMENSIONS



RECOMMENDED PATTERN



Dimensions : mm

ТҮРЕ	TAPE DIMENSIONS					REEL DIMENSIONS		RECC PATT	RECOMMENDED PATTERN		QUANTITY /REEL		
	Α	В	с	D	E	н	Α	В	с	A	В	с	
PMC129	32	20	13.9	13.9	14.2	11.5	330	100	32.5	4	6	6.2	250
PMC127	32	20	13.9	13.9	14.2	9	330	100	32.5	4	6	6.2	250
PMC125	32	20	13.9	13.9	14.2	7	330	100	32.5	4	6	6.2	300

PMC SERIES RELIABILITY TEST

I-I MECHANICAL PERFORMANCE								
NO. ITEM		SPECIFICATION	TEST CONDITIONS					
- -	Vibration	Appearance :No Damage	Test device shall solderd on the substrate					
		L Change :within±10%	Oscillation frequency:10 to 50 to 10HZ for IMin					
		Q Change :within±30%	Amplitude : 1.5mm					
		RDC:within Specificadion	Time :2Hrs,for each Axis (X,Y&Z),Total 6Hrs					
- -2	Resistance to	Appearance :No Damage	Pre-heating: I 50°C , IMin.					
	Soldering Heat		Solder Composition: Sn/Pb=63/37					
			Solder Temperature: 260±5°C					
			Immersion Time: 10± ISec.					
- -3	Solderability	The electrodes shall be at least 90% covered	Pre-heating: I 50°C , IMin.					
		with new solder coating.	Solder Composition: Sn/Pb=63/37					
			Solder Temperature: 230±5°C					
			Immersion Time: 4± ISec.					

I-2 ENVIRONMENTAL PERFORMANCE

NO	ITEM	SPECIFICATION	TEST CONDITIONS					
-2-	Temperature Shock	Appearance: No Damage	10 Cycles (Air to Air) I Cycles shall Consist of: 30Min.Exposure to -55°C 30Min.Exposure to -125°C 15Sec.Max.Transition between Temperatures					
		L Change: within ± 10%						
		L Change: within ± 30%						
		RDC: within Specification						
			Measured afte	tion for 24Hrs.				
1-2-2	Temperature Cycle		One Cycle					
			Step	Temperature(°C)	Time (Min.)			
			1	-25±3	30			
			2	25±2	3			
			3	85±3	30			
			4	25±2	3			
			Total: 100Cycles					
			Measured after Exposure in the Room Condition for 2					
I-2-3	Humidity Resistance		Temperature:	40±2°C				
			Relative Humi	dity: 90~95%				
			Time: 1000Hrs.					
			Measured after	Exposure in the Room Condition 1	for 24Hrs.			
1-2-4	High Temperature		Temperature:	85±3℃				
	Resistance		Relative Humi	Relative Humidity: 20%				
			Applied Curre	ent: Rated Current				
			Time: 1000Hr	ν.				
			Measured after Exposur					
I-2-5	Low Temperature		Temperature:	-25±3°C				
	Resistance		Relative Humi	Relative Humidity: 0%				
			Time: 1000Hr	Time: 1000Hrs.				
			Measured afte	tion for 24Hrs.				